

SL1021A/B Series









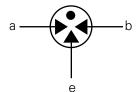
Agency Approvals

AGENCY **SAL**

AGENCY FILE NUMBER

E128662

3 Electrode GDT Graphical Symbol



a = TIP b = RING e = GROUND (center electrode)

Features

- RoHS compliant
- Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 10KA (A suffix devices) / 20KA (B suffix devices) surge capability tested with 8/20µs pulse as defined by IEC 61000-4-5
- Available with thermal failsafe option (add 'F' suffix to part number)

Applications

SL1021:

- Broadband equipment
- ADSL equipment
- XDSL equipment
- Satellite and CATV equipment
- Splitters
- General telecom equipment

- Telecom network interfaces
- Telephone line cards
- Repeaters
- Modems
- Line test equipment

Description

GDT circuit protection devices dissipate electrical surge energy safely within a contained plasma gas. Commonly used to help protect sensitive telecom and networking equipment and lines, GDTs protect from damage that may result from lightning strikes and equipment switching operations.

The Littelfuse GDT series described in this document are available in a variety of leaded and surface mount forms and offered with and without optional fail-safe clip. Please refer to the electrical specifications, dimension and packaging options section of this document for additional information.

SL1021A/B Series:

SL1021A/B series GDTs are designed to offer high levels of performance on fast rising transients in the range of $100V/\mu S$ to $1KV/\mu S$, which are those most likely created by induced lightning disturbances.

These devices feature ultra low capacitance (typically 1.5pF or less) and are extremely robust with SL1021A devices able to divert a 10,000 Amp pulse without destruction, and SL1021B suffix devices able to divert a 20,000 Amp pulse without destruction.

These series offer optimized internal geometry which provide low insertion loss at high frequencies, ideal for the protection of broadband and other high speed transmission equipment.

Product Characteristics

Materials	Dull Tin Plate 17.5 ± 12.5 Microns. with ceramic insulator	
Product Marking	'LF' mark, voltage& date code: SL1021A - Red /White text SL1021B - Blue /White text	
Glow to arc transition current	~ 1Amp	
Glow Voltage	~60-200 Volts	
Storage and Operation Temperature	-40 to +90°C	
Transverse Voltage (Delay Time)	< 0.2μSec (Tested to ITU-T Rec. K.12)	
Arc Voltage	~10 to 35 Volts	
Holdover Voltage	<150mS (Tested to ITU-T Rec. K.12)	



Electrical Characteristics

Device Specifications (at 25°C)					Life Ratings										
Part Number -	DC Voltage 100V/Sec.		DC Voltage 100 V/	DC Voltage 1kV/	Capaci- tance	Insulation Resistance		Surge Current 8/20uSec	Max Single Surge	Max Single Surge	Surge Life 10/1000				
	MIN	TYP	MAX	μSec.	μSec.	(@1Mhz)	MIN	1Sec.x10 ¹	x10 ¹	8/20µSec1	10/350µSec¹	μSecx300¹			
SL1021B075	60	75	90		650		>10 ¹⁰ Ω (at 50V)	10Amps	10kA² 20kA³	15kA² 25kA³	4kA² 5kA³	200Amps			
SL1021A090 SL1021B090	72	90	108												
SL1021A145 SL1021B145	116	145	174	500 600	600	600 650 700 <1.5pF 850 900									
SL1021A150 SL1021B150	120	150	180												
SL1021A200	150	200	250												
SL1021A230 SL1021B230	184	230	276	450	650										
SL1021A250 SL1021B250	200	250	300	500			<1.5pF								
SL1021A260 SL1021B260	210	260	310	550	700										
SL1021A300 SL1021B300	240	300	360	650	850				850	>10 ¹⁰ Ω (at 100V)		2010 (2010 (2.5kA² 5kA³	
SL1021A350 SL1021B350	280	350	420	700	900										
SL1021A400 SL1021B400	320	400	480	850	950										
SL1021A420 SL1021B420	345	420	500			950			U						
SL1021A450 SL1021B450	360	450	540	900	1000										
SL1021A500 SL1021B500	400	500	600	950	1100										
SL1021A600	480	600	720	1000	1200										

NOTES:

- 1. Total current through centre electrode, tested in accordance with ITU-T Rec K.12
- 2. SL1021A series
- 3. SL1021B series

Additional Information



Datasheet SL1021A



Datasheet SL1021B



Resources SL1021A



Resources SL1021B

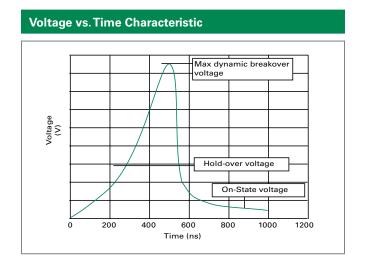


Samples SL1021A



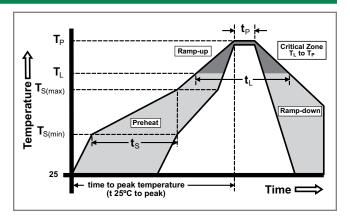
Samples SL1021B

SL102xA with Failsafe SL102xB or PMT8 500 Volt Higher Melting Point Solder SL102xB or PMT8 350 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder SL102xB or PMT8 90 Volt Higher Melting Point Solder



Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Co	ndition	Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (Min to Max) (t _s)	60 – 180 secs	
Average ramp up rate (Liquidus Temp (T _L) to peak		3°C/second max	
T _{S(max)} to T _L - Ramp-up Rate		5°C/second max	
Reflow	-Temperature (T _L) (Liquidus)	217°C	
	-Temperature (t _L)	60 – 150 seconds	
PeakTemp	erature (T _P)	260 ^{+0/-5} °C	
Time within 5°C of actual peak Temperature (t _p)		10 – 30 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C	to peakTemperature (T _P)	8 minutes Max.	
Do not exceed		260°C	

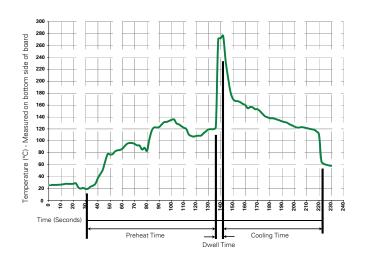


Soldering Parameters - Hand Soldering

Solder Iron Temperature: 350° C +/- 5°C

Heating Time: 5 seconds max.

Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation
Preheat:	
(Depends on Flux Activation Temperature)	(Typical Industry Recommendation)
Temperature Minimum:	100° C
Temperature Maximum:	150° C
Preheat Time:	60-180 seconds
Solder Pot Temperature:	280° C Maximum
Solder Dwell Time:	2-5 seconds

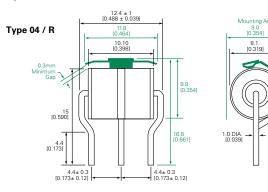
Note: Surge Arrestors with a Failsafe mechanism should be individually examined after soldering

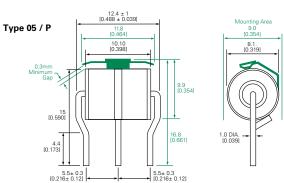


Device Dimensions

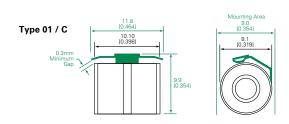
NOTE: Failsafe option dimensions shown in green.

Shaped Radial Leaded Devices:

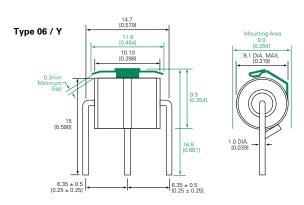




Core Devices:



Straight Radial Leaded Devices:

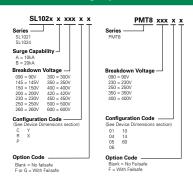


Straight "T" Leaded Devices:

Type "R" is available for SL1021B075 device only.

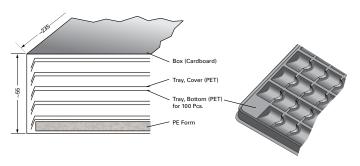


Part Numbering System and Ordering Information

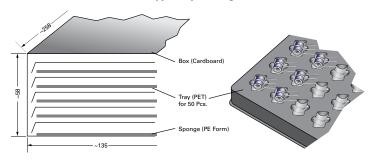


Packaging

For 'SL1021A/B' device type C, R, P, Y packing



For 'SL1021A/B' device type X packing



Device Type	Description	Quantity
Type C	100pcs/tray x 5 trays per carton	500
Type R	100pcs/tray x 5 trays per carton	500
Type P	100pcs/tray x 5 trays per carton	500
Type Y	100pcs/tray x 5 trays per carton	500
Type X	50pcs/tray x 5 trays per carton	250

^{*} Please contact the factory for further packaging information.

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